

Pulp, Paper and Forest Industries Technical Committee Young Engineer Program

March 3, 2017

One of the challenges the Pulp, Paper and Forest Industry faces going forward is attracting and retaining new, young electrical engineering professionals to the industry. Recognizing this need, the IEEE Pulp and Paper Industry Committee (PPIC) has arranged with the IEEE Industrial Applications Society (IAS) to provide a limited number of partial financial sponsorships for young engineers to attend their upcoming 63rd Annual Conference in Tacoma, WA. This provides a low cost way for young engineering professionals to experience this forum for the exchange of electrical applications technology relating to forest products based industries. This is a great way to meet other industry engineers, learn solutions to real mill needs and network with senior professionals from the industry.

What is included?

- ✓ Full Conference Registration
- ✓ One Tutorial
- ✓ Conference Reception
- ✓ Vendor Exhibition
- ✓ Conference Social Event
- ✓ Meals at the Conference
- ✓ Hotel Room Cost

What are the requirements?

1. Full time employee of a Forest Products Industry end-user (Pulp, Paper, Board, Tissue, Lumber, etc.) or consulting engineer working in support of clients in the Forest Products Industry
2. Less than 5 years of experience in the Industry.
3. Never have attended a IEEE Pulp, Paper & Forest Industry Conference previously
4. 30 years of age or younger
5. The young engineering professional must be a full member or student member (or agree to join) the IEEE and the IAS. (IAS registration will be free for 2017 and sign-up will occur at the Conference)
6. The young engineer must attend one PPIC sub-committee meeting and the general committee meeting on Tuesday
7. Only one young engineer per Mill site.
8. You are only responsible for your travel costs

A few highlights from the Conference:

The Conference begins with the Welcome Reception on Sunday Night, June 18, 2017.

The PPIC Sub-committee meetings are on Tuesday, June 20th from 12:00pm until 3pm. The subcommittees are where the papers, tutorials, and other topics are generated for upcoming conferences.



We have four subcommittees consisting of:

- DCS – Drives and Control Systems
- PCEMC – Process Control, Engineering, Maintenance and Construction
- PDS – Power Distribution Systems
- TSSC – Training, Safety, Standards and Codes

We also have the usual selection of great papers and some very interesting tutorials to be presented during the rest of the Conference. Go to www.pulppaper.org for more information.

This sounds like a great opportunity !!

_____ YES, I am interested.

NAME _____

TITLE (Electrical Engineer, Reliability Engineer, etc.) _____

IEEE MEMBER # _____

E-MAIL ADDRESS _____

TUTORIAL YOU WOULD LIKE TO ATTEND _____

COMPANY AND SITE _____

ADDRESS: _____

PHONE NUMBER: _____

COLLEGE _____

DEGREE AND GRADUATION DATE _____

Return information by MAY 12, 2017 via e-mail to:

Greg Drewiske
greg.drewiske@ieee.org

Final selection of the successful applicants will be based on the qualifications listed above, the order that the applications were received, and how many applicants there are from different companies (we'd like to spread the opportunity around as much as possible). Successful applicants will be notified as quickly as possible so they can register and get airline tickets locked in at the best possible rate.

We are looking for feedback as well – If you have questions, comments, or suggestions to make this work better in the future, please send them to Greg Drewiske at the e-mail address listed above.